



1/PORTS

10/506858

DT04 Rec'd PCT/PTO 02 SEP 2004

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DESCRIPTION

DIELECTRIC CERAMIC, MANUFACTURING METHOD THEREOF, AND MULTILAYER CERAMIC CAPACITOR

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Technical Field

The present invention relates to a dielectric ceramic,
a manufacturing method thereof, and a multilayer ceramic
capacitor formed of this dielectric ceramic. In particular,
10 the present invention relates to improvements in dielectric
constant of dielectric ceramic, in temperature
characteristics of the dielectric constant of a dielectric
ceramic layer which is formed of the above dielectric
ceramic and which forms a multilayer ceramic capacitor, and
15 in reliability thereof.

Background Art

A multilayer ceramic capacitor is generally formed as
described below.

20 First, ceramic green sheets are prepared, each having a
conductive material on a surface thereof to be formed into
an interior electrode which has a desired pattern, and each
containing a powdered dielectric ceramic starting material.
As the dielectric ceramic, for example, a ceramic primarily
25 composed of BaTiO_3 is used.

Next, ceramic green sheets including the above-described ceramic green sheets provided with the conductive material are laminated to each other and are then thermally bonded to each other, thereby forming an integrated green
5 laminate.

Next, this green laminate is fired, thereby obtaining a sintered laminate. Inside this laminate, the interior electrodes are formed using the conductive material described above.

10 Subsequently, on exterior surfaces of the laminate, exterior electrodes are formed to be electrically connected to specified interior electrodes. The exterior electrodes are each formed, for example, by applying a conductive paste containing a powdered conductive metal and a glass frit onto
15 the exterior surfaces of the laminate, followed by baking.

As described above, the multilayer capacitor is formed.

In order to reduce the cost for manufacturing a multilayer ceramic capacitor as low as possible, a relatively inexpensive base metal such as nickel or copper
20 has been frequently used in recent years as the conductive material described above for forming the interior electrodes. When a multilayer ceramic capacitor having interior electrodes made of a base metal is manufactured, firing must be performed in a neutral or a reducing atmosphere in order
25 to prevent the base metal from being oxidized in firing.

However, by firing in a neutral or a reducing atmosphere, in general, a ceramic composed, for example, of barium titanate is extremely reduced, and as a result, a problem may arise in that the ceramic is semiconductorized.

5 For solving the problem described above, in order to prevent dielectric ceramic materials from being reduced, various techniques have been proposed (for example, see Japanese Unexamined Patent Application Publication Nos. 8-8137, 2001-97772, 2001-97773, 5-217793, 5-217794, 4-25005,
10 and 11-278930). According to the reduction-preventing techniques of a dielectric ceramic material as mentioned above, manufacturing of a multilayer ceramic capacitor using nickel or the like as an interior electrode material can be performed.

15 In recent years, techniques for forming electronic circuits having a higher density have significantly advanced. Accordingly, a multilayer ceramic capacitor used for the electronic circuits as described above has been increasingly required to be miniaturized and to have a larger capacity.
20 In addition, a multilayer ceramic capacitor may be used in some cases to isolate or buffer an electric source of a microprocessor which is operated at a high speed, and in this case, since an active electron element generates a large amount of heat while being operated at a high speed, a
25 multilayer ceramic capacitor used around a microprocessor is

required to have superior reliability in a high-temperature atmosphere.

Accordingly, even when the thickness of a dielectric ceramic layer forming a multilayer ceramic capacitor can be
5 decreased, it has been desired that a dielectric ceramic material be realized which has a low dielectric loss, superior electrical insulating properties, and high reliability.

Although the dielectric ceramic materials disclosed in
10 Japanese Unexamined Patent Application Publication Nos. 8-8137, 2001-97772, and 2001-97773 have a high relative dielectric constant, crystal grains in the ceramic are grown larger, and when the thickness of a dielectric ceramic layer is decreased, for example, to 3 μm or less, the number of
15 crystal grains present in one dielectric ceramic layer is decreased, and as a result, a problem of degradation in reliability occurs.

Since the dielectric ceramic materials disclosed in Japanese Unexamined Patent Application Publication Nos. 5-
20 217793, 5-217794, and 4-25005 use Ba-Si-Li or Ba-Si-B as a sintering auxiliary agent, problems may arise in that the properties of the dielectric ceramic material largely varies depending on firing conditions and in that the reliability in a high-temperature and high-humidity atmosphere is
25 degraded.

According to the dielectric ceramic material disclosed in Japanese Unexamined Patent Application Publication No. 11-278930, a rare earth element which is added thereto is allowed to be primarily present in crystal grain boundaries so that the reliability by a high-temperature loading test is improved and, in addition, so that a higher relative dielectric constant is obtained. However, according to this dielectric ceramic material disclosed in Japanese Unexamined Patent Application Publication No. 11-278930, as are the materials disclosed in Japanese Unexamined Patent Application Publication Nos. 8-8137, 2001-97772, and 2001-97773, since crystal grains in the ceramic grow large, when the thickness of the dielectric ceramic layer is decreased, for example, to 3 μm or less, the number of crystal grains present in one dielectric ceramic layer is decreased, and as a result, a problem of degradation in reliability occurs.

Hence, an object of the present invention is to provide a dielectric ceramic capable of satisfying the desires described above while the above-described problems are dissolved and to provide a manufacturing method thereof.

Another object of the present invention is to provide a multilayer ceramic capacitor formed using the above-described dielectric ceramic.

Disclosure of Invention

The inventors of the present invention found that when Gd, which is a rare earth element, replaces a part of Ba forming a barium titanate composite oxide and is contained as a solid solution in crystal grains, although the
5 thickness of a dielectric ceramic layer of a multilayer ceramic capacitor is decreased, for example, to 3 μm or less, the reliability under high-temperature loading conditions is improved, and as a result, the present invention was finally made.

10 In order to solve the technical problems described above, a dielectric ceramic of the present invention comprises a primary component composed of a barium titanate base composite oxide represented by the general formula $(\text{Ba}_{1-h-i-m}\text{Ca}_h\text{Sr}_i\text{Gd}_m)_k(\text{Ti}_{1-y-j-n}\text{Zr}_y\text{Hf}_j\text{Mg}_n)\text{O}_3$, in which $0.995 \leq k \leq 1.015$,
15 $0 \leq h \leq 0.03$, $0 \leq i \leq 0.03$, $0.015 \leq m \leq 0.035$, $0 \leq y < 0.05$, $0 \leq j < 0.05$, $0 \leq (y+j) < 0.05$, and $0.015 \leq n \leq 0.035$ hold, Ba is partly replaced with Gd, and Ti is partly replaced with Mg; and an additive component containing Ma (Ma is at least one of Ba, Sr, and Ca), Mb (Mb is at least one of Mn and Ni), and Mc (Mc is Si
20 or includes both Si and Ti), in which Ma is contained in an amount of less than 1.5 moles (however, 0 moles are not included) with respect to 100 moles of the primary component, Mb is contained in an amount of less than 1.0 mole (however, 0 moles are not included) with respect to 100 moles of the
25 primary component, and Mc is contained in an amount in the

range of from 0.5 to 2.0 moles with respect to 100 moles of the primary component.

In the dielectric ceramic of the present invention, it is important that the primary component is represented by the general formula $(\text{Ba}_{1-h-i-m}\text{Ca}_h\text{Sr}_i\text{Gd}_m)_k(\text{Ti}_{1-y-j-n}\text{Zr}_y\text{Hf}_j\text{Mg}_n)\text{O}_3$. That is, it is important that Gd and Mg are not simply contained as an additive component, Gd replaces a part of Ba and is contained as a solid solution in the primary component, and Mg replaces a part of Ti and is contained as a solid solution in the primary component. For example, when a material containing a calcined BaTiO_3 base compound and Gd and/or Mg simply added thereto is fired, it has been already known that Gd in a solid solution form cannot be sufficiently present at Ba sites, and that Mg in a solid solution form cannot be sufficiently present at Ti sites.

The dielectric ceramic according to the present invention preferably further comprises, with respect to 100 moles of the primary component, 0.5 moles or less of R_2O_3 (R is at least one of a lanthanoid element except Gd, Y, and Sc) as a subcomponent.

In addition, the dielectric ceramic according to the present invention preferably further comprises, with respect to 100 moles of the primary component, 1 mole or less of Al_2O_3 .

The present invention may also be applied to a method

for manufacturing the dielectric ceramic as described above.

First, a method for manufacturing a dielectric ceramic, according to the present invention, comprises a first step of obtaining a reaction product composed of a barium titanate base composite oxide represented by the general formula $(\text{Ba}_{1-h-i-m}\text{Ca}_h\text{Sr}_i\text{Gd}_m)_k(\text{Ti}_{1-y-j-n}\text{Zr}_y\text{Hf}_j\text{Mg}_n)\text{O}_3$, in which $0.995 \leq k \leq 1.015$, $0 \leq h \leq 0.03$, $0 \leq i \leq 0.03$, $0.015 \leq m \leq 0.035$, $0 \leq y < 0.05$, $0 \leq j < 0.05$, $0 \leq (y+j) < 0.05$, and $0.015 \leq n \leq 0.035$ hold, Ba is partly replaced with Gd, and Ti is partly replaced with Mg.

In addition, a step of preparing Ma (Ma is at least one of Ba, Sr, and Ca), Mb (Mb is at least one of Mn and Ni), and Mc (Mc is Si or includes both Si and Ti) is performed.

Subsequently, a third step of mixing the reaction product obtained in the first step and Ma, Mb, and Mc prepared in a second step is carried out so that less than 1.5 moles of Ma (however, 0 moles are not included) is contained with respect to 100 moles of the reaction product, less than 1.0 mole of Mb (however, 0 moles are not included) is contained with respect to 100 moles of the reaction product, and 0.5 to 2.0 moles of Mc is contained with respect to 100 moles of the reaction product.

Next, a fourth step of firing the mixture obtained in the third step is performed.

In the method for manufacturing a dielectric ceramic, according to the present invention, in the third step

described above, 0.5 moles or less of R_2O_3 (R is at least one of a lanthanoid element except Gd, Y, and Sc) is preferably further mixed as a subcomponent with respect to 100 moles of the reaction product.

5 In addition, in the method for manufacturing a dielectric ceramic, according to the present invention, 1 mole or less of Al_2O_3 is preferably further mixed with respect to 100 moles of the reaction product in the third step described above.

10 The present invention may be further applied to a multilayer ceramic capacitor which comprises: a laminate having dielectric ceramic layers which are laminated to each other and interior electrodes which are provided along specific interfaces between dielectric ceramic layers and
15 which are overlapped with each other in the lamination direction; and exterior electrodes formed on exterior surfaces of the laminate so as to be electrically connected to specific interior electrodes.

20 In the multilayer ceramic capacitor according to the present invention, the dielectric ceramic layers described above each comprise the dielectric ceramic according to the present invention, and the interior electrodes each comprise a base metal as a primary component.

25 According to the dielectric ceramic of the present invention as described above, when a dielectric ceramic

layer for forming a multilayer ceramic capacitor is formed therefrom, since sintering stability is superior, the humidity resistance is improved, the F characteristics of the JIS standard and the Y5V characteristics of the EIA standard are satisfied, the relative dielectric constant is 9,000 or more, and the multilayer ceramic capacitor can be used in a wide temperature range.

In addition, since the humidity resistance and the high-temperature reliability are superior although the thickness of the dielectric ceramic layer is decreased, a miniaturized multilayer ceramic capacitor having a larger capacity can be realized by decreasing the thickness, and in addition, it is not necessary to decrease a rated voltage. Accordingly, even when the thickness of the dielectric ceramic layer is decreased, for example, to 3 μm or less, practically sufficient characteristics can be imparted to the multilayer ceramic capacitor.

In addition, even when being fired in a neutral or a reducing atmosphere, the dielectric ceramic of the present invention is not semiconductorized and may have a high specific resistance. Accordingly, when a multilayer ceramic capacitor is formed using this dielectric ceramic, a base metal can be used as a conductive component contained in interior electrodes without causing any problems, and as a result, cost of the multilayer ceramic capacitor can be

reduced.

When 0.5 moles or less of R_2O_3 (R is at least one of a lanthanoid element except Gd, Y, and Sc) is further contained in the dielectric ceramic according to the present invention as a subcomponent with respect to 100 moles of the primary component, the lifetime under high-temperature loading conditions and/or the sintering properties can be further improved.

In addition, when 1 mole or less of Al_2O_3 is further contained in the dielectric ceramic according to the present invention with respect to 100 moles of the primary component, the sintering properties can be further improved.

According to the method for manufacturing a dielectric ceramic of the present invention, since the reaction product composed of a barium titanate base composite oxide is obtained in which Ba is partly replaced with Gd and Ti is partly replaced with Mg, and the necessary additive components are mixed with this reaction product, as the primary component, a dielectric ceramic can be easily and reliably obtained containing the barium titanate base composite oxide in which Ba is partly replaced with Gd and Ti is partly replaced with Mg.

Brief Description of the Drawings

Fig. 1 is a cross-sectional view schematically showing

a multilayer ceramic capacitor 1 formed using a dielectric ceramic according to the present invention.

Best Mode for Carrying Out the Invention

5 As shown in Fig. 1, a multilayer ceramic capacitor 1 has a laminate 2 in the form of a rectangular parallelepiped on the whole. The laminate 2 is formed of a plurality of dielectric ceramic layers 3 which are laminated to each other and a plurality of interior electrodes 4 and 5 which
10 are formed along a plurality of specific interfaces between the dielectric ceramic layers 3. The interior electrodes 4 and 5 are formed to extend to exterior surfaces of the laminate 2, and the interior electrodes 4 extending to one end surface 6 of the laminate 2 and the interior electrodes
15 5 extending to the other end surface 7 are alternately disposed in the laminate 2.

 Onto the end surfaces 6 and 7, which are the exterior surfaces of the laminate 2, a conductive paste is applied and is then baked, thereby forming respective exterior
20 electrodes 8 and 9. Whenever necessary, on the exterior electrodes 8 and 9, first plating layers 10 and 11 made of nickel, copper, a nickel-copper alloy, or the like are formed, and on the plating layers thus formed, second plating layers 12 and 13 made of solder, tin, or the like
25 are formed.

As described above, in the multilayer ceramic capacitor 1, the interior electrodes 4 and 5 are formed so as to be overlapped with each other in the lamination direction of the laminate 2, and hence static capacitances are formed between the adjacent interior electrodes 4 and 5. In addition, the interior electrodes 4 are electrically connected to the exterior electrode 8, and in addition, the interior electrodes 5 are also electrically connected to the exterior electrode 9; hence, the static capacitances described above are obtained through those exterior electrodes 8 and 9.

The dielectric ceramic layer 3 is formed from the following dielectric ceramic which is the feature of the present invention.

That is, the dielectric ceramic layer 3 is formed from a dielectric ceramic which comprises a primary component of a barium titanate base composite oxide represented by the general formula $(\text{Ba}_{1-h-i-m}\text{Ca}_h\text{Sr}_i\text{Gd}_m)_k(\text{Ti}_{1-y-j-n}\text{Zr}_y\text{Hf}_j\text{Mg}_n)\text{O}_3$, in which $0.995 \leq k \leq 1.015$, $0 \leq h \leq 0.03$, $0 \leq i \leq 0.03$, $0.015 \leq m \leq 0.035$, $0 \leq y < 0.05$, $0 \leq j < 0.05$, $0 \leq (y+j) < 0.05$, and $0.015 \leq n \leq 0.035$ hold, Ba is partly replaced with Gd, and Ti is partly replaced with Mg; and an additive component containing Ma (Ma is at least one of Ba, Sr, and Ca), Mb (Mb is at least one of Mn and Ni), and Mc (Mc is Si or includes both Si and Ti), in which Ma is contained in an amount of less than 1.5 moles (however, 0

moles are not included) with respect to 100 moles of the primary component, Mb is contained in an amount of less than 1.0 mole (however, 0 moles are not included) with respect to 100 moles of the primary component, and Mc is contained in
5 an amount in the range of from 0.5 to 2.0 moles with respect to 100 moles of the primary component.

When the dielectric ceramic layer 3 is formed using the dielectric ceramic as described above, the humidity resistance is improved due to the sintering stability, the F
10 characteristic specified by the JIS standard and the Y5V characteristic specified by the EIA standard are satisfied, the relative dielectric constant ϵ is 9,000 or more, and an accelerated lifetime of insulating resistance under high-temperature and high-voltage conditions is increased; hence,
15 even when the thickness of the dielectric ceramic layer is decreased, a compact and large-capacity multilayer ceramic capacitor 1 having superior reliability can be realized. In addition, since this dielectric ceramic can be fired in a neutral or a reducing atmosphere, a base metal such as
20 nickel, a nickel alloy, copper, or a copper alloy can be used as a material for the interior electrodes 4 and 5. In addition, a small amount of a ceramic powder may be added to a metal material forming the interior electrodes 4 and 5.

The dielectric ceramic forming the dielectric ceramic
25 layer 3 preferably further contains 0.5 moles or less of R_2O_3

(R is at least one of a lanthanoid element except Gd, Y, and Sc) as a subcomponent with respect to 100 moles of the above mentioned primary component. Accordingly, the lifetime under high-temperature loading conditions and/or the sintering properties can be further improved.

In addition, the dielectric ceramic forming the dielectric ceramic layer 3 preferably further contains 1.0 mole or less of Al_2O_3 with respect to 100 moles of the primary component. Accordingly, the sintering properties can be further improved.

The composition of the exterior electrodes 8 and 9 is not specifically limited. The exterior electrodes 8 and 9 may be each formed, for example, of a sintered body using one of various conductive metal powders such as silver, palladium, a silver-palladium alloy, copper, and a copper alloy, or may be each formed of a sintered body composed of one of the above-mentioned conductive metal powders and a glass frit such as $\text{B}_2\text{O}_3\text{-Li}_2\text{O-SiO}_2\text{-BaO}$, $\text{B}_2\text{O}_3\text{-SiO}_2\text{-BaO}$, $\text{Li}_2\text{O-SiO}_2\text{-BaO}$, or $\text{B}_2\text{O}_3\text{-SiO}_2\text{-ZnO}$ base material. In addition, when the content is small, in addition to the conductive metal powder and the glass frit mentioned above, a ceramic powder may also be added.

Next, while a method for manufacturing the multilayer ceramic capacitor 1 shown in Fig. 1 is described, an embodiment of a manufacturing method of the dielectric

ceramic of the present invention will be described.

First, a powdered starting material of the dielectric ceramic forming the dielectric ceramic layer 3 is prepared. The powdered starting material is preferably formed as described below.

That is, a step is first performed for obtaining a reaction product composed of a barium titanate base composite oxide represented by the general formula $(\text{Ba}_{1-h-i-m}\text{Ca}_h\text{Sr}_i\text{Gd}_m)_k(\text{Ti}_{1-y-j-n}\text{Zr}_y\text{Hf}_j\text{Mg}_n)\text{O}_3$, in which $0.995 \leq k \leq 1.015$, $0 \leq h \leq 0.03$, $0 \leq i \leq 0.03$, $0.015 \leq m \leq 0.035$, $0 \leq y < 0.05$, $0 \leq j < 0.05$, $0 \leq (y+j) < 0.05$, and $0.015 \leq n \leq 0.035$ hold, Ba is partly replaced with Gd, and Ti is partly replaced with Mg.

In more particular, in order to obtain the reaction product, compounds containing the individual elements included in the above general formula, such as powdered BaCO_3 , TiO_2 , CaCO_3 , SrCO_3 , ZrO_2 , HfO_2 , Gd_2O_3 , and MgO , are mixed together so as to have the composition ratios described above and are then calcined in the air, followed by pulverization.

In this step, as the compounds containing the individual elements included in the above general formula, compounds other than the carbonates or oxides mentioned above may also be used in order to obtain the reaction product described above. In addition, besides the calcination method mentioned above as a synthetic method for

obtaining the reaction product, an alkoxide method, a coprecipitation method, a hydrothermal synthesis method, and the like may also be used.

In addition, Ma (Ma is at least one of Ba, Sr, and Ca),
5 Mb (Mb is at least one of Mn and Ni), and Mc (Mc is Si or includes both Si and Ti) are prepared. In more particular, powdered BaCO_3 , SrCO_3 , CaCO_3 , MnO , NiO , TiO_2 , and SiO_2 are prepared.

Next, Ma, Mb, and Mc described above are mixed with the
10 above reaction product so that a mixture is formed in which less than 1.5 moles (however, 0 moles are not included) of Ma is contained with respect to 100 moles of the reaction product, less than 1.0 moles (however, 0 moles are not included) of Mb is contained with respect to 100 moles of
15 the reaction product, and 0.5 to 2.0 moles of Mc is contained with respect to 100 moles of the reaction product. This mixture is used as the powdered starting material of the dielectric ceramic.

In the above mixing step in which Ma, Mb, and Mc are
20 added, the individual powdered compounds may be separately added, or after at least two types of individual compounds are allowed to react with each other to form a powdered composite oxide, the addition may then be performed. In the latter case, a calcination method in the air may be used for
25 the reaction, and an alkoxide method, a coprecipitation

method, a hydrothermal synthesis method, and the like may also be used.

When the powdered starting material is prepared as described above, a dielectric ceramic which satisfies the conditions as described above can be easily obtained.

In the above mixing step, with respect to 100 moles of the reaction product, as a subcomponent, 0.5 moles or less of R_2O_3 (R is at least one of a lanthanoid element except Gd, Y, and Sc) may be further mixed. In addition, in the mixing step, with respect to 100 moles of the reaction product, 1 mole or less of Al_2O_3 may be further mixed.

As for an alkaline metal oxide such as Na_2O or K_2O which may be present as an impurity in the powdered reaction product used as the primary component, it has been verified that the content has a relatively significant influence on electrical properties. However, it has also been verified that when the content of the alkali metal oxide which may be present as an impurity is less than 0.02 percent by weight of the primary component represented by $(Ba_{1-h-i-m}Ca_hSr_iGd_m)_k(Ti_{1-y-j-n}Zr_yHf_jMg_n)O_3$, the electrical properties are not degraded.

Next, an organic binder and a solvent are added to the powdered starting material obtained as described above, followed by mixing, thereby forming a slurry. By using the slurry thus formed, ceramic green sheets to be formed into

the dielectric ceramic layers 3 are formed.

Next, on specific ceramic green sheets, conductive paste films to be formed into the interior electrodes 4 and 5 are formed, for example, by screen printing. This conductive paste film contains a base metal, such as nickel, a nickel alloy, copper, or a copper alloy, as a conductive component. In addition to the printing method such as a screen printing method, the interior electrodes 4 and 5 may also be formed, for example, by a deposition method or a plating method.

Next, after the ceramic green sheets provided with the conductive paste films as described above are laminated to each other, and in addition, ceramic green sheets which are not provided with the conductive paste films are laminated so as to sandwich the above-described ceramic green sheets, followed by compression bonding, cutting is performed whenever necessary, thereby obtaining a green laminate which is to be formed into the laminate 2. In this green laminate, the conductive paste films are each exposed at one of the end surfaces thereof.

Next, the green laminate is fired in a reducing atmosphere. By this step, the fired laminate 2 as shown in Fig. 1 is obtained, and in the laminate 2, the ceramic green sheets described above made of the dielectric ceramic each form the dielectric ceramic layer 3, and the conductive

paste films form the interior electrodes 4 and 5.

The average crystal grain diameter of the dielectric ceramic forming the dielectric ceramic layer 3 described above is preferably set to 2.5 μm or less, more preferably 1.5 μm or less, and even more preferably 1 μm or less.

Next, the exterior electrodes 8 and 9 are formed on the end surfaces 6 and 7 of the laminate 2 by baking the conductive paste so as to be electrically connected to the respective exposed ends of the interior electrodes 4 and 5.

As described above, the exterior electrodes 8 and 9 are generally formed by applying a conductive paste on the exterior surfaces of the fired laminate 2, followed by baking; however, they may be formed by applying a conductive paste on the exterior surfaces of the green laminate before firing, followed by baking which is simultaneously performed with the firing carried out for obtaining the laminate 2.

Subsequently, whenever necessary, on the exterior electrodes 8 and 9, plating of nickel, copper, or the like is performed, thereby forming the first plating layers 10 and 11. Then, on the first plating layers 10 and 11, plating of solder, tin, or the like is performed, thereby forming the second plating layers 12 and 13.

As described above, the multilayer ceramic capacitor 1 is formed.

Next, the present invention will be described in

particular with reference to experimental examples. The experimental examples also have meaning of showing the reasons the scope of the present invention or a preferable scope thereof is defined.

5 (Experimental Example 1)

As starting materials for a dielectric ceramic, powdered BaCO_3 , CaCO_3 , SrCO_3 , TiO_2 , ZrO_2 , HfO_2 , Gd_2O_3 , MgCO_3 , MnO , NiO , and SiO_2 , each having a purity of 99.8% or more, were prepared.

10 Next, in order to obtain a first reaction product represented by $(\text{Ba}_{1-h-i-m}\text{Ca}_h\text{Sr}_i\text{Gd}_m)_k(\text{Ti}_{1-y-j-n}\text{Zr}_y\text{Hf}_j\text{Mg}_n)\text{O}_3$, specified materials among the above starting materials were mixed together in accordance with the composition in the column of "First Reaction Product" shown in Tables 1 and 2
15 and were then calcined in the air, followed by pulverization.

In addition, in order to obtain a second reaction product containing Ma (at least one of Ba, Sr, and Ca), Mb (at least one of Mn and Ni), and Mc (Si or both Si and Ti), specified materials among the above starting materials were
20 mixed together in accordance with the composition in the column of "Second Reaction Product" shown in Tables 1 and 2 and were calcined in the air, followed by pulverization.

In the column of "Second Reaction Product" in Tables 1 and 2, respective elements used as Ma, Mb, and Mc and molar
25 ratios thereof are represented by "molar ratio/element".

This molar ratio shows a molar ratio between Ma, Mb, and Mc, and also shows a molar ratio with respect to 100 moles of the first reaction product.

5

TABLE 1

SAMPLE NO.	FIRST REACTION PRODUCT							SECOND REACTION PRODUCT		
		Ca	Sr	Zr	Hf	Gd	Mg	Ma	Mb	Mc
	k	H	i	y	j	m	n	MOLAR RATIO/ ELEMENT	MOLAR RATIO/ ELEMENT	MOLAR RATIO/ ELEMENT
1-1	0.995	0.00	0.00	0.03	0.00	0.025	0.025	0.4/Ba	0.5/Mn	0.8/Si
1-2	1.015	0.00	0.00	0.03	0.00	0.025	0.025	0.2/Ba 0.1/Ca	0.3/Mn	1.0/Si 0.4/Ti
1-3	1.000	0.03	0.00	0.03	0.00	0.025	0.025	0.8/Ba	0.3/Mn 0.1/Ni	1.2/Si
1-4	1.000	0.00	0.03	0.03	0.00	0.025	0.025	0.8/Ba	0.3/Mn	0.9/Si
1-5	1.000	0.00	0.00	0.04	0.00	0.025	0.025	0.8/Ba 0.6/Sr	0.4/Mn	1.0/Si
1-6	1.000	0.00	0.00	0.00	0.04	0.025	0.025	0.8/Ba	0.2/Mn 0.2/Ni	0.9/Si 0.1/Ti
1-7	1.000	0.00	0.00	0.02	0.02	0.025	0.025	0.8/Ba	0.2/Mn 0.2/Ni	0.9/Si 0.1/Ti
1-8	1.000	0.00	0.00	0.03	0.00	0.015	0.025	0.8/Ba	0.6/Mn	0.8/Si
1-9	1.000	0.00	0.00	0.03	0.00	0.035	0.025	0.4/Ba	0.4/Mn	1.3/Si 0.2/Ti
1-10	1.000	0.00	0.00	0.03	0.00	0.025	0.015	0.8/Ba	0.6/Mn	0.7/Si
1-11	1.000	0.00	0.00	0.03	0.00	0.025	0.035	0.2/Ba	0.3/Mn	1.4/Si 0.1/Ti
1-12	0.997	0.00	0.00	0.03	0.00	0.025	0.025	0.1/Ba	0.3/Mn	0.7/Si
1-13	1.001	0.00	0.00	0.03	0.00	0.025	0.025	0.7/Ba 0.7/Ca	0.4/Mn	1.4/Si
1-14	1.000	0.00	0.00	0.03	0.00	0.025	0.025	0.8/Sr	0.3/Mn 0.1/Ni	1.0/Si
1-15	1.000	0.00	0.00	0.03	0.00	0.025	0.025	0.2/Ba	0.1/Mn	1.3/Si
1-16	1.000	0.00	0.00	0.03	0.00	0.025	0.025	0.8/Ba	0.9/Ni	0.7/Si 0.2/Ti
1-17	1.000	0.00	0.00	0.03	0.00	0.025	0.025	0.3/Ba	0.3/Mn 0.1/Ni	0.3/Si 0.2/Ti
1-18	1.000	0.00	0.00	0.03	0.00	0.025	0.025	0.8/Ba	0.6/Mn	2.0/Si

TABLE 2

SAMPLE NO.	FIRST REACTION PRODUCT							SECOND REACTION PRODUCT		
		Ca	Sr	Zr	Hf	Gd	Mg	Ma	Mb	Mc
	k	H	i	y	j	m	n	MOLAR RATIO/ ELEMENT	MOLAR RATIO/ ELEMENT	MOLAR RATIO/ ELEMENT
* 1-101	0.992	0.00	0.00	0.03	0.00	0.025	0.025	0.4/Ba	0.5/Mn	0.8/Si
* 1-102	1.018	0.00	0.00	0.03	0.00	0.025	0.025	0.2/Ba 0.1/Ca	0.3/Mn	1.0/Si 0.4/Ti
* 1-103	1.000	0.05	0.00	0.03	0.00	0.025	0.025	0.8/Ba	0.3/Mn 0.1/Ni	1.2/Si
* 1-104	1.000	0.00	0.05	0.03	0.00	0.025	0.025	0.8/Ba	0.3/Mn	0.9/Si
* 1-105	1.000	0.00	0.00	0.06	0.00	0.025	0.025	0.8/Ba 0.6/Sr	0.4/Mn	1.0/Si
* 1-106	1.000	0.00	0.00	0.00	0.06	0.025	0.025	0.8/Ba	0.2/Mn 0.2/Ni	0.9/Si 0.1/Ti
* 1-107	1.000	0.00	0.00	0.02	0.04	0.025	0.025	0.8/Ba	0.2/Mn 0.2/Ni	0.9/Si 0.1/Ti
* 1-108	1.000	0.00	0.00	0.03	0.00	0.012	0.025	0.8/Ba	0.6/Mn	0.8/Si
* 1-109	1.000	0.00	0.00	0.03	0.00	0.038	0.025	0.4/Ba	0.4/Mn	1.3/Si 0.2/Ti
* 1-110	1.000	0.00	0.00	0.03	0.00	0.025	0.012	0.8/Ba	0.6/Mn	0.7/Si
* 1-111	1.000	0.00	0.00	0.03	0.00	0.025	0.038	0.2/Ba	0.3/Mn	1.4/Si 0.1/Ti
* 1-112	0.995	0.00	0.00	0.03	0.00	0.025	0.025	0.0	0.3/Mn	0.7/Si
* 1-113	1.002	0.00	0.00	0.03	0.00	0.025	0.025	0.9/Ba 0.8/Ca	0.4/Mn	1.4/Si
* 1-114	1.000	0.00	0.00	0.03	0.00	0.025	0.025	0.2/Ba	0.0	1.3/Si
* 1-115	1.000	0.00	0.00	0.03	0.00	0.025	0.025	0.8/Ba	1.2/Ni	0.7/Si 0.2/Ti
* 1-116	1.000	0.00	0.00	0.03	0.00	0.025	0.025	0.3/Ba	0.3/Mn 0.1/Ni	0.2/Si 0.1/Ti
* 1-117	1.000	0.00	0.00	0.03	0.00	0.025	0.025	0.8/Ba	0.6/Mn	2.2/Si

Next, the second reaction products were added so as to
5 have molar ratios as shown in Tables 1 and 2 with respect to
100 moles of the first reaction product, and the mixtures
thus obtained were used as powdered dielectric ceramic
starting materials for individual samples.

Next, to each of the powdered dielectric ceramic

starting materials shown in Tables 1 and 2, a polyvinyl butyral base binder and an organic solvent such as ethanol were added, followed by wet mixing using a ball mill, thereby forming a ceramic slurry.

5 Next, the ceramic slurry was formed into a sheet shape by a doctor blade method, so that rectangular ceramic green sheets were obtained each of which was to have a thickness of 3 μm after firing.

10 Next, onto each of the ceramic green sheets, a conductive paste primarily composed of nickel was applied, thereby forming a conductive paste film to be formed into an interior electrode.

15 Next, the ceramic green sheets were laminated to each other so that ends thereof to which the above conductive paste films extended were alternately disposed, thereby obtaining a green laminate.

20 Next, after the green laminate was heated to a temperature of 350°C in a nitrogen atmosphere to burn away the binder, in a reducing atmosphere composed of a $\text{H}_2\text{-N}_2\text{-H}_2\text{O}$ gas at an oxygen partial pressure of 10^{-9} to 10^{-12} MPa, firing was performed for 2 hours at a corresponding temperature among those shown in Tables 3 and 4, thereby obtaining a sintered laminate.

25 Next, onto two end surfaces of the sintered laminate, a conductive paste containing silver as a conductive component

in addition to a B_2O_3 - Li_2O - SiO_2 - BaO base glass frit was applied and was fired at a temperature of $600^\circ C$ in a nitrogen atmosphere, thereby forming exterior electrodes electrically connected to the interior electrodes.

5 The exterior dimensions of the multilayer ceramic capacitor thus formed were 1.6 mm wide, 3.2 mm long, and 1.2 mm thick, and the thickness of the dielectric ceramic layer present between the interior electrodes was 3 μm . In addition, the number of effective dielectric ceramic layers
10 was 100, and a counter electrode area per layer was 2.1 mm^2 .

For the samples thus obtained, the following evaluations were performed.

First, the relative dielectric constant (ϵ) was obtained at a temperature of $25^\circ C$ by application of 1 V_{rms} at 1 kHz.

15 In addition, by using a static capacitance at a temperature of $20^\circ C$ as the basis, the minimum and the maximum rate of change in capacitance by AC application of 1 V_{rms} at 1 kHz in the range of from -25 to $+85^\circ C$ were measured for evaluation whether the F characteristic was satisfied or
20 not. In addition, by using a static capacitance at a temperature of $25^\circ C$ as the basis, the minimum and the maximum rate of change in capacitance by AC application of 1 V_{rms} at 1 kHz in the range of from -30 to $+85^\circ C$ were measured for evaluation whether the Y5V characteristic was satisfied
25 or not.

In addition, in a static capacitance-temperature curve in the range of from -25 to 85°C obtained in an AC electric field of $25\text{ V}_{\text{rms}}/\text{mm}$ at 1 kHz , a temperature was measured at which a peak capacitance was obtained. In this case, when

5 the AC voltage is increased, an apparent capacitance in a temperature range in which the ferroelectricity is observed is increased, and as a result, the temperature of the peak capacitance is shifted to a lower temperature side.

Accordingly, in this measurement, an electric field of 25

10 $\text{V}_{\text{rms}}/\text{mm}$ was used which was sufficiently low so that the peak temperature was not shifted.

In addition, a high-temperature loading lifetime test was performed. The high-temperature loading lifetime test was a test for obtaining the change in insulating resistance

15 with time from 36 test pieces at a temperature of 150°C by applying 30 volts thereto so as to have an electric field of $10\text{ kV}/\text{mm}$. As the high-temperature loading lifetime, times at which the insulating resistance of the individual samples reached $200\text{ k}\Omega$ or less were regarded as the lifetime, and

20 the average lifetime was obtained therefrom.

In addition, the cross section of the dielectric ceramic layer of the multilayer ceramic capacitor formed from each of the samples was photographed using a scanning electron microscope, and crystal grain diameters were

25 obtained from the photograph thus taken. Subsequently,

after 30 crystals or more were selected, the average value of the crystal grain diameters was obtained.

The evaluation results are shown in Tables 3 and 4.

TABLE 3

SAMPLE NO.	FIRING TEMPERATURE (°C)	RELATIVE DIELECTRIC CONSTANT	F CHARACTERISTIC	Y5V CHARACTERISTIC	TEMPERATURE OF PEAK CAPACITANCE AT LOW ELECTRIC FIELD (°C)	AVERAGE LIFETIME UNDER HIGH-TEMPERATURE LOADING CONDITIONS (HOURS)	AVERAGE CRYSTAL GRAIN DIAMETER (μm)
1-1	1200	10500	WITHIN SPECIFICATION	WITHIN SPECIFICATION	75	25	2.3
1-2	1230	9100	WITHIN SPECIFICATION	WITHIN SPECIFICATION	10	40	1.4
1-3	1220	9200	WITHIN SPECIFICATION	WITHIN SPECIFICATION	47	35	1.3
1-4	1240	9600	WITHIN SPECIFICATION	WITHIN SPECIFICATION	0	25	1.7
1-5	1220	9800	WITHIN SPECIFICATION	WITHIN SPECIFICATION	5	17	2.0
1-6	1230	9600	WITHIN SPECIFICATION	WITHIN SPECIFICATION	10	16	1.5
1-7	1220	9400	WITHIN SPECIFICATION	WITHIN SPECIFICATION	8	18	1.4
1-8	1210	10700	WITHIN SPECIFICATION	WITHIN SPECIFICATION	55	15	2.4
1-9	1240	9700	WITHIN SPECIFICATION	WITHIN SPECIFICATION	-5	38	1.6
1-10	1210	10600	WITHIN SPECIFICATION	WITHIN SPECIFICATION	59	27	2.2
1-11	1240	9200	WITHIN SPECIFICATION	WITHIN SPECIFICATION	-3	40	1.3
1-12	1200	11800	WITHIN SPECIFICATION	WITHIN SPECIFICATION	80	23	2.3
1-13	1240	9600	WITHIN SPECIFICATION	WITHIN SPECIFICATION	36	38	1.3
1-14	1230	10400	WITHIN SPECIFICATION	WITHIN SPECIFICATION	22	29	2.1
1-15	1230	10000	WITHIN SPECIFICATION	WITHIN SPECIFICATION	35	18	2.0
1-16	1230	9100	WITHIN SPECIFICATION	WITHIN SPECIFICATION	20	32	1.2
1-17	1250	9400	WITHIN SPECIFICATION	WITHIN SPECIFICATION	32	24	1.4
1-18	1190	11000	WITHIN SPECIFICATION	WITHIN SPECIFICATION	57	18	2.5

TABLE 4

SAMPLE NO.	FIRING TEMPERATURE (°C)	RELATIVE DIELECTRIC CONSTANT	F CHARACTERISTIC	Y5V CHARACTERISTIC	TEMPERATURE OF PEAK CAPACITANCE AT LOW ELECTRIC FIELD (°C)	AVERAGE LIFETIME UNDER HIGH-TEMPERATURE LOADING CONDITIONS (HOURS)	AVERAGE CRYSTAL GRAIN DIAMETER (μm)
* 1-101	1180	11500	WITHIN SPECIFICATION	WITHIN SPECIFICATION	85	6	2.8
* 1-102	1260	8400	WITHIN SPECIFICATION	WITHIN SPECIFICATION	0	48	1.3
* 1-103	1240	8000	WITHIN SPECIFICATION	WITHIN SPECIFICATION	53	28	1.2
* 1-104	1250	9000	WITHIN SPECIFICATION	WITHIN SPECIFICATION	-15	5	1.5
* 1-105	1230	9400	WITHIN SPECIFICATION	WITHIN SPECIFICATION	-17	2	2.0
* 1-106	1230	9300	WITHIN SPECIFICATION	WITHIN SPECIFICATION	-15	4	1.8
* 1-107	1230	9200	WITHIN SPECIFICATION	WITHIN SPECIFICATION	-13	4	1.4
* 1-108	1200	11400	OUTSIDE SPECIFICATION	OUTSIDE SPECIFICATION	63	6	2.5
* 1-109	1250	8800	WITHIN SPECIFICATION	WITHIN SPECIFICATION	-15	46	1.2
* 1-110	1210	11300	OUTSIDE SPECIFICATION	OUTSIDE SPECIFICATION	63	20	2.5
* 1-111	1250	8100	WITHIN SPECIFICATION	WITHIN SPECIFICATION	-13	42	0.9
* 1-112	1180	12600	OUTSIDE SPECIFICATION	OUTSIDE SPECIFICATION	90	2	3.0
* 1-113	1270	8600	WITHIN SPECIFICATION	WITHIN SPECIFICATION	40	43	1.1
* 1-114	1250				SEMICONDUCTORIZED		
* 1-115	1240	8900	WITHIN SPECIFICATION	WITHIN SPECIFICATION	15	38	1.2
* 1-116	1280	8200	WITHIN SPECIFICATION	WITHIN SPECIFICATION	17	22	1.0
* 1-117	1180	12000	OUTSIDE SPECIFICATION	OUTSIDE SPECIFICATION	65	2	3.5

In Tables 1 to 4, sample Nos. provided with asterisks * are samples outside of the scope of the present invention.

According to samples 1-1 to 1-18 within the scope of the present invention, $0.995 \leq k \leq 1.015$, $0 \leq h \leq 0.03$, $0 \leq i \leq 0.03$,
5 $0 \leq y < 0.05$, $0 \leq j < 0.05$, $0.015 \leq m \leq 0.035$, $0.015 \leq n \leq 0.035$, and
 $0 \leq (y+j) < 0.05$ held, and individual conditions in which less than 1.5 moles of Ma was contained with respect to 100 moles of the first reaction product, less than 1.0 mole of Mb was contained with respect to 100 moles of the first reaction
10 product, and 0.5 to 2.0 moles of Mc was contained with respect to 100 moles of the first reaction product were satisfied as shown in Table 1.

As a result, according to samples 1-1 to 1-18, firing at a temperature of 1,250°C or less can be performed, a
15 relative dielectric constant of 9,000 or more can be obtained, the F characteristic and the Y5V characteristic are each within the specification, and the average lifetime under high-temperature loading conditions is relatively long as shown in Table 3.

20 On the other hand, in sample 1-101 which is outside the scope of the present invention, since the k value is less than 0.995 as shown in Table 2, the average lifetime under high-temperature loading conditions is short as shown in Table 4. In addition, in sample 1-102 which is outside the
25 scope of the present invention, the k value is more than

1.015 as shown in Table 2; hence, as shown in Table 4, the firing temperature is more than 1,250°C, and the relative dielectric constant is less than 9,000.

5 In sample 1-103 which is outside the scope of the present invention, since the h value is more than 0.03 as shown in Table 2, the relative dielectric constant is less than 9,000 as shown in Table 4.

10 In sample 1-104 which is outside the scope of the present invention, since the i value is more than 0.03 as shown in Table 2, the average lifetime under high-temperature loading conditions is short as shown in Table 4.

15 In samples 1-105 and 1-106, which are outside the scope of the present invention, as shown in Table 2, since the y value and the j value are each 0.05 or more, and in sample 1-107 which is outside the scope of the present invention, the (y + j) value is 0.05 or more. As a result, according to samples 1-105, 1-106, and 1-107, as shown in Table 4, the average lifetime under high-temperature loading conditions is short.

20 In sample 1-108 which is outside the scope of the present invention, since the m value is less than 0.015 as shown in Table 2, the F characteristic and the Y5V characteristic are outside the specifications as shown in Table 4. In addition, in sample 1-109 which is outside the scope of the present invention, since the m value is more

25

than 0.035 as shown in Table 2, the relative dielectric constant is less than 9,000 as shown in Table 4.

In sample 1-110 which is outside the scope of the present invention, since the n value is less than 0.015 as shown in Table 2, the F characteristic and the Y5V characteristic are outside the specifications as shown in Table 4. In addition, in sample 1-111 which is outside the scope of the present invention, since the n value is more than 0.035 as shown in Table 2, the relative dielectric constant is less than 9,000 as shown in Table 4.

In sample 1-112 which is outside the scope of the present invention, as shown in Table 2, Ma is not contained; hence, as shown in Table 4, the F characteristic and the Y5V characteristic are outside the specifications, and the average lifetime under high-temperature loading conditions is short. In addition, in sample 1-113 which is outside the scope of the present invention, as shown in Table 2, more than 1.5 moles of Ma is contained; hence, as shown in Table 4, the firing temperature exceeds 1,250°C, and the relative dielectric constant is less than 9,000.

In sample 1-114 which is outside the scope of the present invention, since Mb is not contained as shown in Table 2, the sintered body is semiconductorized as shown in Table 4. In addition, in sample 1-115 which is outside the scope of the present invention, since more than 1.0 mole of

Mb is contained as shown in Table 2, the relative dielectric constant is less than 9,000 as shown in Table 4.

In sample 1-116 which is outside the scope of the present invention, as shown in Table 2, only less than 0.5
5 moles of Mc is contained; hence, as shown in Table 4, the firing temperature exceeds 1,250°C, and in addition, the relative dielectric constant is less than 9,000. In addition, in sample 1-117 which is outside the scope of the present invention, as shown in Table 2, more than 2.0 moles
10 of Mc is contained; hence, as shown in Table 4, the F characteristic and the Y5V characteristic are outside the specifications, and in addition, the average lifetime under high-temperature loading conditions is short.

(Experimental Example 2)

15 As starting materials of the dielectric ceramic, powdered BaCO₃, TiO₂, ZrO₂, HfO₂, Gd₂O₃, MgCO₃, CaCO₃, SrCO₃, MnO, NiO, and SiO₂, each having a purity of 99.8% or more, were prepared, and in addition to powdered R₂O₃ in which R was an element shown in the column of "R₂O₃" in Table 5,
20 powdered Al₂O₃ was also prepared.

Next, in order to obtain a first reaction product represented by (Ba_{0.97}Ca_{0.01}Gd_{0.02})_{0.999}(Ti_{0.95}Zr_{0.02}Hf_{0.01}Mg_{0.02})O₃, predetermined amounts of BaCO₃, TiO₂, ZrO₂, HfO₂, Gd₂O₃, MgCO₃, and CaCO₃ among the above mentioned starting materials were
25 mixed together and were then calcined in the air, followed

by pulverization.

In addition, in order to obtain a second reaction product containing Ma, Mb, and Mc, BaCO_3 , SrCO_3 , MnO , NiO , SiO_2 , and TiO_2 among the above starting materials were mixed together so that molar ratios of Ba: Sr: Mn: Ni: Si: Ti with respect to 100 moles of the first reaction product were set to 0.6: 0.1: 0.3: 0.1: 0.8: 0.2, and were then calcined in the air, followed by pulverization.

Next, with respect to 100 moles of the first reaction product, in addition to the second reaction product having the above molar ratios, R_2O_3 including an element shown in Table 5 was added at a molar ratio shown in Table 5, and Al_2O_3 was also added at a molar ratio shown in Table 5, thereby forming a mixture used as the powdered dielectric ceramic starting material.

Hereinafter, by the same methods as described in Experimental Example 1, multilayer ceramic capacitors were formed, and the same evaluations as described above were performed. The evaluation results are shown in Table 5.

TABLE 5

SAMPLE NO.	R ₂ O ₃	Al ₂ O ₃	FIRING TEMPERATURE (°C)	RELATIVE DIELECTRIC CONSTANT	F CHARACTERISTIC	Y5V CHARACTERISTIC	TIME OF PEAK CAPACITANCE AT LOW ELECTRIC FIELD (°C)	AVERAGE LIFETIME UNDER HIGH-TEMPERATURE LOADING CONDITIONS (HOURS)	AVERAGE CRYSTAL GRAIN DIAMETER (μm)
	MOLAR RATIO/ ELEMENT	MOLAR RATIO							
2-1	0.5/Sc	0.00	1240	9800	WITHIN SPECIFICATION	WITHIN SPECIFICATION	20	34	1.3
2-2	0.5/Y	0.00	1240	9600	WITHIN SPECIFICATION	WITHIN SPECIFICATION	20	32	1.3
2-3	0.5/La	0.00	1220	11000	WITHIN SPECIFICATION	WITHIN SPECIFICATION	55	15	2.4
2-4	0.5/Ce	0.00	1220	10800	WITHIN SPECIFICATION	WITHIN SPECIFICATION	55	18	2.4
2-5	0.5/Pr	0.00	1220	10600	WITHIN SPECIFICATION	WITHIN SPECIFICATION	50	20	2.2
2-6	0.5/Nd	0.00	1220	10600	WITHIN SPECIFICATION	WITHIN SPECIFICATION	50	20	2.0
2-7	0.5/Pm	0.00	1220	10400	WITHIN SPECIFICATION	WITHIN SPECIFICATION	45	23	2.0
2-8	0.5/Sm	0.00	1230	10200	WITHIN SPECIFICATION	WITHIN SPECIFICATION	45	25	1.7
2-9	0.5/Eu	0.00	1230	10200	WITHIN SPECIFICATION	WITHIN SPECIFICATION	40	28	1.7
2-10	0.5/Tb	0.00	1230	9800	WITHIN SPECIFICATION	WITHIN SPECIFICATION	30	30	1.3
2-11	0.5/Dy	0.00	1240	9700	WITHIN SPECIFICATION	WITHIN SPECIFICATION	25	32	1.3
2-12	0.5/Ho	0.00	1240	9500	WITHIN SPECIFICATION	WITHIN SPECIFICATION	20	34	1.3
2-13	0.5/Er	0.00	1250	9400	WITHIN SPECIFICATION	WITHIN SPECIFICATION	15	34	1.1
2-14	0.5/Tm	0.00	1250	9300	WITHIN SPECIFICATION	WITHIN SPECIFICATION	10	37	1.1
2-15	0.5/Yb	0.00	1250	9100	WITHIN SPECIFICATION	WITHIN SPECIFICATION	5	40	1.0
2-16	0.5/Lu	0.00	1250	9000	WITHIN SPECIFICATION	WITHIN SPECIFICATION	0	42	1.0
2-17	0.0	1.00	1200	12000	WITHIN SPECIFICATION	WITHIN SPECIFICATION	45	16	2.5
2-18	0.0	0.00	1250	10100	WITHIN SPECIFICATION	WITHIN SPECIFICATION	35	20	1.4

As shown in Table 5, compared to sample 2-18 in which R_2O_3 was not contained, it was confirmed that in samples 2-1 to 2-16 in which 0.5 moles or less of R_2O_3 was contained with respect to 100 moles of the first reaction product used as a primary component, the lifetime under high-temperature loading conditions is improved and/or the sintering properties are improved.

In addition, compared to sample 2-18 in which Al_2O_3 was not contained, it was also confirmed that in sample 2-17 in which 1 mole or less of Al_2O_3 was contained with respect to 100 moles of the first reaction product used as a primary component, the sintering properties are improved.

(Experimental Example 3)

As starting materials of a dielectric ceramic, powdered $BaCO_3$, $SrCO_3$, TiO_2 , ZrO_2 , Gd_2O_3 , $MgCO_3$, MnO , and SiO_2 , each having a purity of 99.8% or more, were prepared.

Next, by the use of the starting materials mentioned above, the powdered dielectric ceramic starting materials such as samples 3-1 to 3-5 were formed. In all the samples 3-1 to 3-5, the molar ratios of Ba: Sr: Gd; Ti: Zr: Mg: Mn: Si were set to 96.4: 2: 2: 96: 2: 2: 0.2: 1.5.

(1) Sample 3-1

In order to obtain a first reaction product represented by $(Ba_{0.96}Sr_{0.02}Gd_{0.02})(Ti_{0.96}Zr_{0.02}Mg_{0.02})O_3$, predetermined amounts of $BaCO_3$, $SrCO_3$, Gd_2O_3 , TiO_2 , ZrO_2 , and $MgCO_3$ among the above

starting materials were mixed together and were then calcined in the air, followed by pulverization.

In addition, in order to obtain a second reaction product containing Ma, Mb, and Mc, BaCO_3 , MnO , and SiO_2 among
5 the above starting materials were mixed together so that 0.4 moles of Ba, 0.2 moles of Mn, and 1.5 moles of Si were contained with respect to 100 moles of the first reaction product, and were then calcined in the air, followed by pulverization.

10 Subsequently, the first reaction product and the second reaction product were mixed together to form the powdered dielectric ceramic starting material.

(2) Sample 3-2

By the same manufacturing method as that for the first
15 reaction product of sample 3-1, a reaction product represented by $(\text{Ba}_{0.96}\text{Sr}_{0.02}\text{Gd}_{0.02})(\text{Ti}_{0.96}\text{Zr}_{0.02}\text{Mg}_{0.02})\text{O}_3$ was obtained.

Next, BaCO_3 , MnO , and SiO_2 , which were the starting materials, were mixed together so as to form a powdered
20 dielectric ceramic starting material in which 0.4 moles of Ba, 0.2 moles of Mn, and 1.5 moles of Si were contained with respect to 100 moles of the reaction product.

(3) Sample 3-3

Predetermined amounts of the individual starting
25 materials were mixed together so that the molar ratios of

Ba: Sr: Gd: Ti: Zr: Mg: Mn: Si were set to 96.4: 2: 2: 96: 2: 2: 0.2: 1.5, and were then calcined in the air, followed by pulverization; hence, the powdered dielectric ceramic starting material was obtained.

5 (4) Sample 3-4

In order to obtain a first reaction product represented by $(\text{Ba}_{0.98}\text{Sr}_{0.02})(\text{Ti}_{0.98}\text{Zr}_{0.02})\text{O}_3$, predetermined amounts of BaCO_3 , SrCO_3 , TiO_2 , and ZrO_2 among the above starting materials were mixed together and were then calcined in the air, followed
10 by pulverization. In this case, it should be worthy of note that Gd and Mg are not contained.

In addition, in order to obtain a second reaction product containing Ba and Si, BaCO_3 and SiO_2 among the starting materials were mixed together so that 0.4 moles of
15 Ba and 1.5 moles of Si were obtained with respect to 98 moles of the first reaction product, and were then calcined in the air, followed by pulverization.

Subsequently, while the first reaction product and the second reaction product were mixed together, Gd_2O_3 , MgCO_3 ,
20 and MnO among the starting materials were added so that 2 moles of Gd, 2 moles of Mg, and 0.2 moles of Mn were contained with respect to 98 moles of the first reaction product, thereby forming the powdered dielectric ceramic starting material.

25 (5) Sample 3-5

As was the case of sample 3-4, a first reaction product represented by $(\text{Ba}_{0.98}\text{Sr}_{0.02})(\text{Ti}_{0.98}\text{Zr}_{0.02})\text{O}_3$ was obtained.

In addition, in order to obtain a second reaction product containing Ba, Gd, and Si, BaCO_3 , Gd_2O_3 , and SiO_2 among the starting materials were mixed together so that 0.4 moles of Ba, 2 moles of Gd, and 1.5 moles of Si were contained with respect to 98 moles of the first reaction product, and were then calcined in the air, followed by pulverization.

Subsequently, while the first reaction product and the second reaction product were mixed together, MgCO_3 and MnO among the starting materials were added so that 2 moles of Mg and 0.2 moles of Mn were contained with respect to 98 moles of the first reaction product, thereby forming the powdered dielectric ceramic starting material.

Hereinafter, as was the case of Experimental Example 1, multilayer ceramic capacitors were formed, and the same evaluations as described above were performed. Furthermore, in Experimental Example 3, a humidity-resistance lifetime test was performed.

In the humidity-resistance lifetime test, by using 36 samples, a voltage of 15 V is applied to each sample at a temperature of 85°C and a humidity of 85% so that an electric field of 5 kV/mm was realized for measuring the change in insulating resistance with time. In this

evaluation, as the humidity-resistance lifetime, times at which insulating resistance of individual samples reached 200 k Ω or less were regarded as the lifetime, and the average lifetime was obtained therefrom.

- 5 The results of the evaluations described above are shown in Table 6.

TABLE 6

SAMPLE NO.	FIRING TEMPERATURE (°C)	RELATIVE DIELECTRIC CONSTANT	F CHARACTERISTIC	Y5V CHARACTERISTIC	TIME OF PEAK CAPACITANCE AT LOW ELECTRIC FIELD (°C)	AVERAGE LIFETIME UNDER HIGH-TEMPERATURE LOADING CONDITIONS (HOURS)	AVERAGE HUMIDITY-RESISTANCE LIFETIME (HOURS)	AVERAGE CRYSTAL GRAIN DIAMETER (μm)
3-1	1230	10800	WITHIN SPECIFICATION	WITHIN SPECIFICATION	45	25	20	1.5
3-2	1240	10300	WITHIN SPECIFICATION	WITHIN SPECIFICATION	40	20	13	1.3
* 3-3	1250	12000	WITHIN SPECIFICATION	WITHIN SPECIFICATION	50	2	1	3.5
* 3-4	1230	8500	WITHIN SPECIFICATION	WITHIN SPECIFICATION	18	28	15	1.0
* 3-5	1230	7900	WITHIN SPECIFICATION	WITHIN SPECIFICATION	7	35	22	0.8

7-10

In Table 6, sample Nos. provided with asterisks * are samples outside of the scope of the present invention.

According to samples 3-1 and 3-2 within the scope of the present invention, since Gd and Mg in a solid solution
5 form are contained in the first reaction product used as the primary component of the powdered dielectric ceramic starting material, superior properties are obtained, as shown in Table 6. In particular, it should be worthy of note that a relative dielectric constant of 9,000 or more is
10 obtained and that the high-temperature loading lifetime test and the humidity lifetime test show superior results.

On the other hand, according to sample 3-3 which is outside the scope of the present invention, since it was synthesized so that Ma, Mb, and Mc were contained in the
15 primary component, the average crystal grain diameter of the obtained dielectric ceramic is large compared to samples 3-1 and 3-2, and in addition, the lifetime under high-temperature loading conditions and the humidity-resistance lifetime are both decreased.

20 In addition, according to samples 3-4 and 3-5 which are outside of the scope of the present invention, since Ba and Ti in a BaTiO_3 base composite oxide used as the primary component of the powdered dielectric ceramic starting material are not partly replaced with Gd and Mg,
25 respectively, the relative dielectric constant is low, such

as less than 9,000, compared to samples 3-1 and 3-2.

(Experimental Example 4)

As starting materials of a dielectric ceramic, powdered BaCO_3 , TiO_2 , ZrO_2 , HfO_2 , MgCO_3 , CaCO_3 , MnO , NiO , and SiO_2 ,
5 each having a purity of 99.8% or more, were prepared, and as Re_2O_3 , powdered Gd_2O_3 , Nd_2O_3 , Dy_2O_3 were prepared.

Next, in order to obtain a first reaction product represented by $(\text{Ba}_{0.965}\text{Ca}_{0.01}\text{Re}_{0.025})(\text{Ti}_{0.955}\text{Zr}_{0.01}\text{Hf}_{0.01}\text{Mg}_{0.025})\text{O}_3$, predetermined amounts of specific powdered compounds among
10 the above starting materials were mixed together and were then calcined in the air, followed by pulverization. In this step, as shown in Table 7, as Re_2O_3 which was one of the starting materials, Gd_2O_3 was used for sample 4-1, Nd_2O_3 was used for sample 4-2, and Dy_2O_3 was used for sample 4-3.

15 In addition, in order to obtain a second reaction product containing Ma, Mb, and Mc, BaCO_3 , CaCO_3 , MnO , NiO , SiO_2 , and TiO_2 among the above starting materials were used, and predetermined amounts thereof were mixed together so that molar ratios of Ba: Ca: Mn: Ni: Si: Ti with respect to
20 100 moles of the first reaction product were set to 0.5: 0.2: 0.2: 0.4: 1.2: 0.2, and were then calcined in the air, followed by pulverization.

Next, the first reaction product and the second reaction product were mixed together, thereby forming the
25 powdered dielectric ceramic starting material.

Subsequently, as was the case of Experimental Example 1, multilayer ceramic capacitors were formed, and the same evaluations as described above were performed. The evaluation results are shown in Table 7.

TABLE 7

SAMPLE NO.	Re	FIRING TEMPERATURE (°C)	RELATIVE DIELECTRIC CONSTANT	F CHARACTERISTIC	Y5V CHARACTERISTIC	TIME OF PEAK CAPACITANCE AT LOW ELECTRIC FIELD (°C)	AVERAGE LIFETIME UNDER HIGH-TEMPERATURE LOADING CONDITIONS (HOURS)	AVERAGE CRYSTAL GRAIN DIAMETER (μm)
4-1	Gd	1230	10800	WITHIN SPECIFICATION	WITHIN SPECIFICATION	28	34	2.2
* 4-2	Nd	1210	12600	WITHIN SPECIFICATION	WITHIN SPECIFICATION	47	6	3.0
* 4-3	Dy	1250	7800	WITHIN SPECIFICATION	WITHIN SPECIFICATION	20	62	0.7

In Table 7, sample Nos. provided with asterisks * are samples outside of the scope of the present invention.

According to sample 4-1 within the scope of the present invention, since Gd is selected as an element for replacing
5 a part of Ba which forms a BaTiO_3 base composite oxide which is the first reaction product used as a primary component, as shown in Table 7, superior properties are obtained. In particular, it should be worthy of note that a relative dielectric constant of 9,000 or more is obtained and that
10 the high-temperature loading lifetime test shows a superior result.

On the other hand, since Nd is selected as an element for replacing a part of Ba which forms a BaTiO_3 base composite oxide which is the first reaction product used as
15 a primary component according to sample 4-2 which is outside the scope of the present invention, the humidity-resistance lifetime is short, compared to sample 4-1, as shown in Table 7.

In addition, since Dy is selected as an element for
20 replacing a part of Ba which forms a BaTiO_3 base composite oxide which is the first reaction product used as a primary component according to sample 4-3 which is outside the scope of the present invention, the relative dielectric constant is less than 9,000, as shown in Table 7.

25 Industrial Applicability